

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1 (Currently Amended): A semiconductive glaze product comprising a glaze composition and a flux, the glaze composition containing a KNaO-MgO-CaO-Al₂O₃-SiO₂-based base glaze in which the compositional proportions as represented by the Seger formula of basic components[; i.e.], mainly KNaO, MgO, and CaO, are 0.1 to 0.4, 0.2 to 0.6, and balance, respectively, and containing a metal oxide composition including tin oxide and antimony oxide, wherein the amount of the flux is 10 parts by weight or less on the basis of 100 parts by weight of the glaze composition.

Claim 2 (Original): The semiconductive glaze product according to claim 1, wherein the flux is boron oxide.

Claim 3 (Currently Amended): The semiconductive glaze product according to claim 1 ~~or 2~~, wherein the compositional proportions as represented by the Seger formula of Al₂O₃, and SiO₂ constituting the base glaze are 0.5 to 0.9 and 4 to 7, respectively.

Claim 4 (Currently Amended): The semiconductive glaze product according to ~~any one of claims 1 to 3~~ claim 1, wherein the amounts of the base glaze and the metal oxide composition contained in the glaze composition are 60 to 80 wt.% and 40 to 20 wt.%, respectively.

Claim 5 (Currently Amended): The semiconductive glaze product according to ~~any one of claims 1 to 4~~ claim 1, wherein the antimony oxide content of the metal oxide composition is 2 to 15 wt.%.

Claim 6 (Currently Amended): The semiconductive glaze product according to ~~any one of claims 1 to 5~~ claim 1, wherein the metal oxide composition contains niobium oxide in an amount of 5 wt.% or less.

Claim 7 (Currently Amended): A method for producing a semiconductive glaze product comprising mixing predetermined amounts of a flux and a glaze composition containing a base glaze and a metal oxide, the flux and the glaze composition serving as raw materials; and adding water to the resultant mixture to thereby form a slurry, wherein particles of the raw materials[[: i.e.]], mainly the glaze composition and the flux, are reduced in size such that large particles having a size of at least 10 μm account for 15 wt.% or less of the entirety of the particulate raw material mixture.

Claim 8 (Original): The method for producing a semiconductive glaze product according to claim 7, wherein wollastonite is employed as a Ca source.

Claim 9 (Currently Amended): ~~[[A]]~~ An insulator comprising an insulator main body whose surface is coated with a semiconductive glaze product as recited in claim 1 ~~any one of claims 1 to 6~~.